DENTAL LIGHT-CURE BONDING AGENT

CLEARFIL TRI-S BOND PLUS

Stronger than Before, Faster than Ever and Simple as Always.

CLEARFIL S³ BOND PLUS is a light-cure, self-etching, one-step, fluoride-releasing bonding agent. Based on the same progressive adhesive technologies from the gold standard; **CLEARFIL SE BOND** you can expect minimal postoperative sensitivity.

With its one-bottle liquid, **CLEARFIL S³ BOND PLUS** dramatically simplifies bonding procedures. Along with Kuraray's MDP technology, a new catalyst has been adopted; thereby, providing higher bond strength with improved working time.

CLEARFIL S³ BOND PLUS has minimal technique sensitivity, and is indicated for light-cure composites, root surface treatment and cavity sealing. CLEARFIL S³ BOND PLUS is exceptional for use in pedodontic restorative procedures where speed and comfort are extremely critical.

CLEARFIL S³ BOND PLUS when utilized with our complementary component **CLEARFIL DC CORE PLUS** can achieve dual-cure core build-up/post cementation without an additional bottle.





One-Step Self-Etch: No-Shaking, No-Mixing, No-Scrubbing, No Multiple Applications

SAME FEATURES AS CLEARFIL S3 BOND

- Swift and Simple: No-Shaking, No-Mixing, No Scrubbing, No Multiple Applications
- MDP Technology Provides a Water-Resistant Chemical Bond to Enamel and Dentin without Etching
- Perfect for Root Surface Treatment and Cavity Sealing
- Virtually No Post-Operative Sensitivity

"PLUS" FEATURES

- Fluoride-Releasing
- New Integrated Catalyst for Advanced Bond Strength
- Post Cementation and Dual-cure Core Build-Ups using CLEARFIL DC CORE PLUS

KURARAY'S MDP TECHNOLOGY:



CLEARFIL S³ BOND PLUS contains the same original monomer MDP created by Kuraray, which is the key for reliable adhesion to tooth structure and restorations.

MDP Technology enables *CLEARFIL S³ BOND PLUS* to chemically interlock with the calcium in both enamel and dentin, creating a highly durable water-proof seal.

MDP has been utilized in the well-recognized and established dental adhesive and resin cement:

- CLEARFIL SE BOND
- PANAVIA

QUICK & SIMPLE APPLICATION:

- 1. Apply bond for 10 sec.
- 2. Dry with mild pressure air flow for 5 sec.*
- 3. Light-cure for 10 sec. (curing time by Halogen/LED)
- * Bond contains ethanol, which could lower the bond strength if it is not dried completely.



ORDERING INFORMATION:

ITEM#	PRODUCT NAME	CONTENTS
#2890KA	CLEARFIL S ³ BOND PLUS Set	 Bond (4 ml) Applicator brush (fine 50 pcs) Dispensing dish Light-blocking plate
#2893KA	CLEARFIL S³ BOND PLUS VALUE Pack	3 Bond (4 ml)
#2898KA	CLEARFIL S ³ BOND PLUS Unit Dose Standard Pack (50 pcs)	50 Unit-dose 0.1 ml applications
#2899KA	CLEARFIL S ³ BOND PLUS Unit Dose Value Pack (100 pcs)	100 Unit-dose 0.1 ml applications

RELATED PRODUCT:

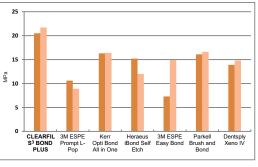


CLEARFIL DC CORE PLUS

is a dual-cure, radiopaque core buildup material supplied in a convenient automix delivery system, which is perfect for post cementation. With CLEARFIL S³ BOND PLUS it's fast and easy; providing exceptional bond strength to dentin.

Comparison of CLEARFIL S³ BOND PLUS and other Leading Bonding Agents

Tensile Bond Strength to: Enamel and Dentin after 4000 Thermal-Cycles



Enamel Dentin

*Source: KURARAY MEDICAL INC

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